

Types of Encapsulant Materials and Physical Differences Between Them



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Purposes of Polymer Materials in PV

Helps Protect Cell Materials From Environmental Stress

- Must Provide Good Adhesion.
- Resistant to Heat, Humidity, UV Radiation, and Thermal Cycling.

Electrical Isolation

Control, reduce, or eliminate moisture ingress.

Optically Couples Glass to Cells

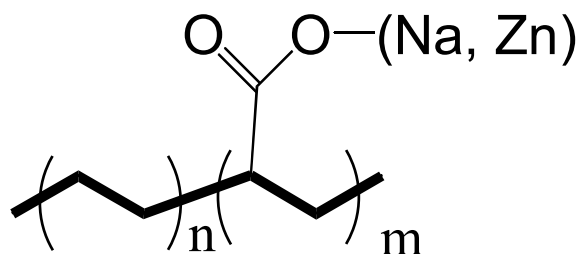
- High Photon Transmission.

Cost Must Be Balanced With Performance.

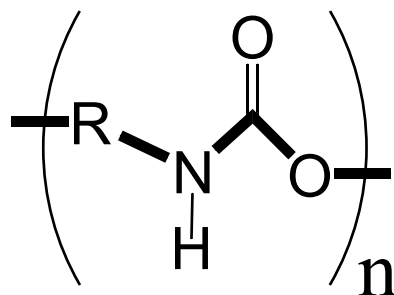
Outline

Encapsulant Chemistry
Optical Transmission
Electrical insulation
Moisture ingress

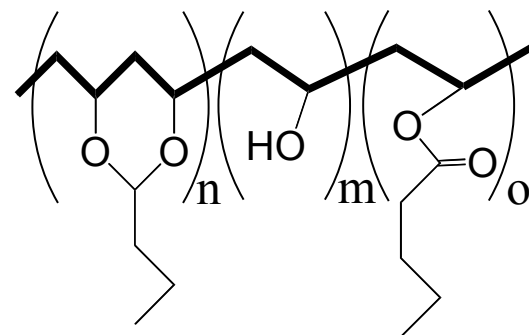
Encapsulant Materials Structures



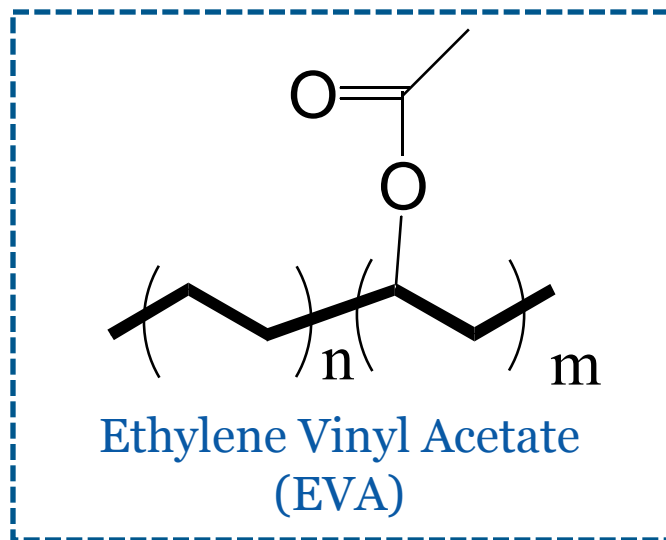
Ionomer



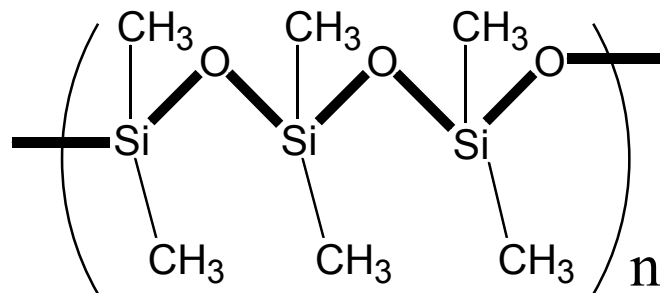
Thermoplastic Polyurethane
(TPU)



Polyvinyl Butyral
(PVB)

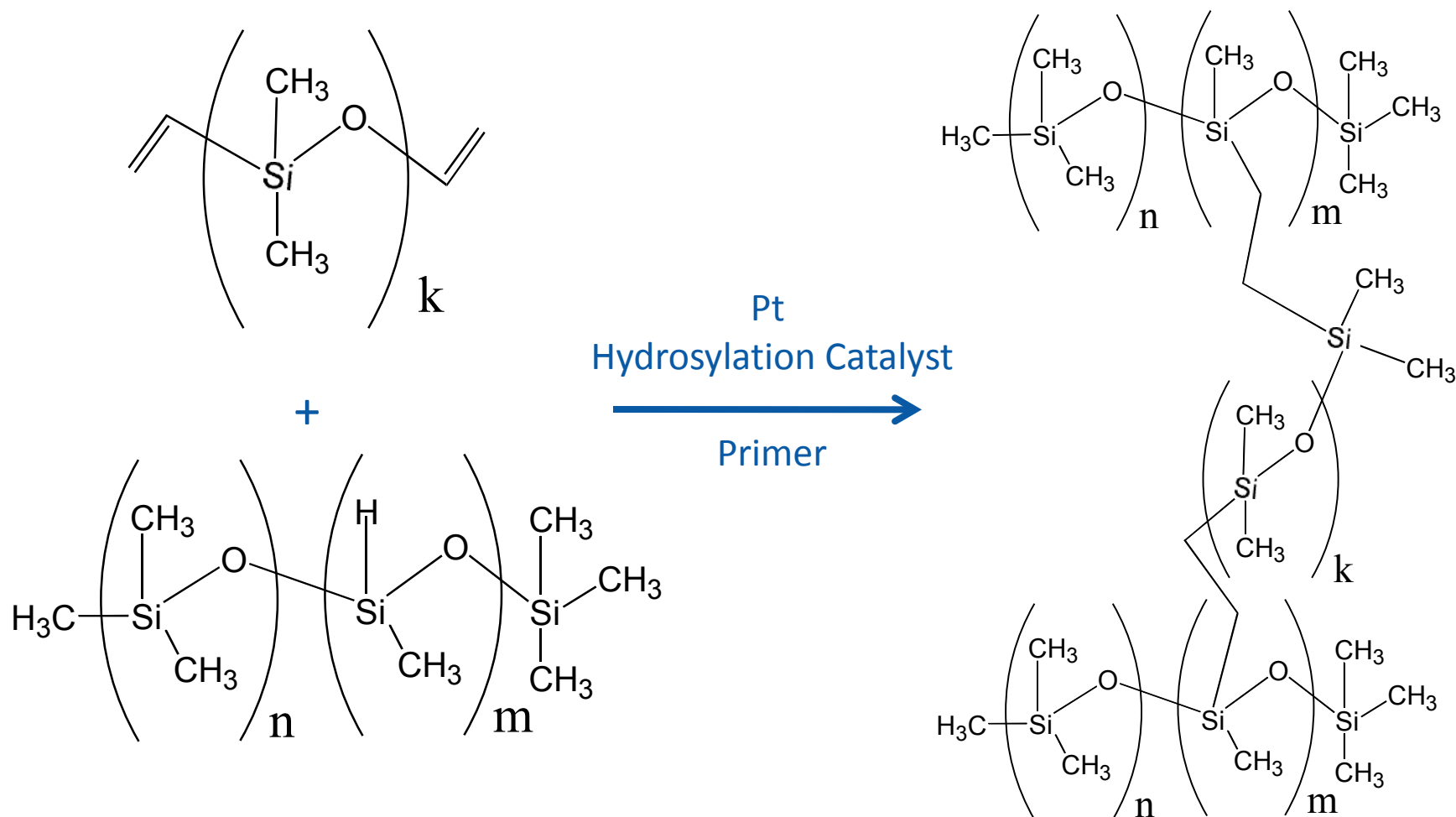


Ethylene Vinyl Acetate
(EVA)



Polydimethyl Silicone
(PDMS)

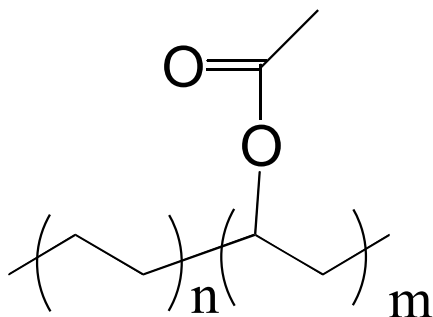
Early PV Modules Used PDMS



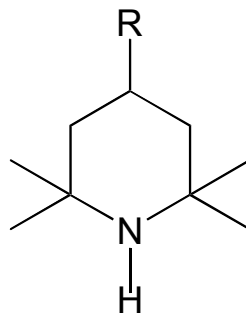
Dow Corning Corporation, "Develop silicone Encapsulation Systems for Terrestrial Silicon Solar Arrays", Doe/JPL954995-2 (1978).

M. A. Green, "Silicon Photovoltaic Modules: A Brief History of the First 50 Years", Prog. Photovolt: Res. Appl. **13**, (2005) 447-455.

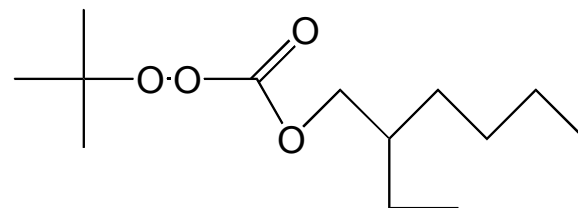
EVA Film Composition



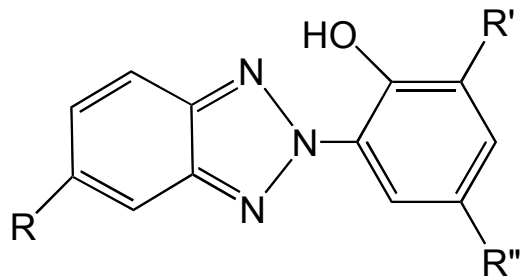
Ethylene Vinyl Acetate
(EVA, 96% to 98%)



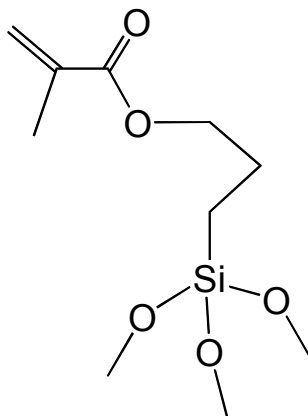
Hinder Amine Light Stabilizer
(HALS, 0.1% to 0.2%)
Decomposes Peroxide Radicals



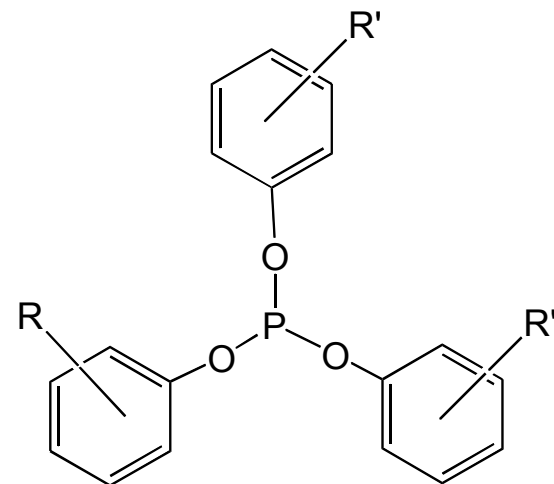
Peroxide
(1% to 2%)
Cross-Linker



Benzotriazole
(0.2% to 0.35%)
UV Absorber



Trialkoxy Silane
(0.2% to 1%)
Adhesion Promoter

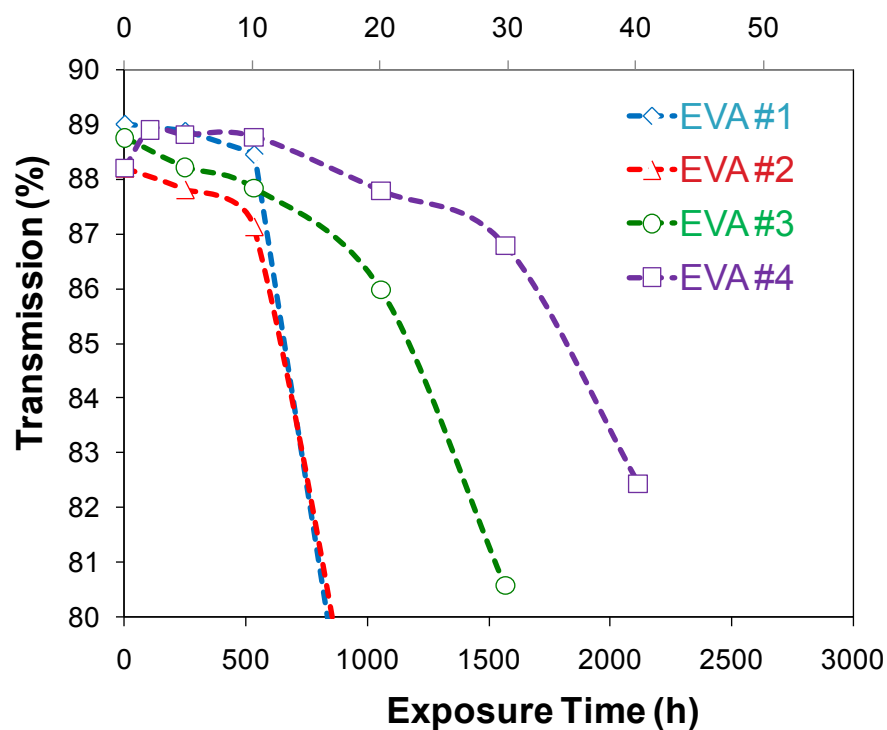


Phenolic Phosphonite
(0.1% to 0.2%)
Peroxide Decomposer/
Radical Scavenger

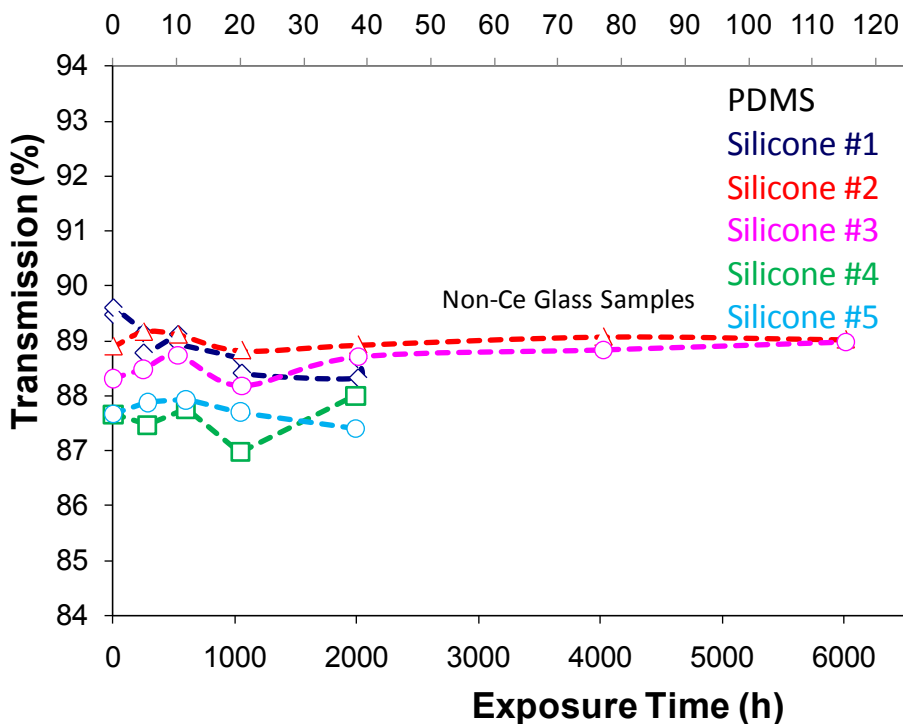
The PDMS Samples Did Not Degrade

Exposure of encapsulant materials to 42 UV suns at 80°C to 95°C.
Samples between 3.18mm low Fe non-Ce glass.

1 Sun Global Non-Tracking Years Irradiance



1 Sun Global Non-Tracking Years Equivalent Irradiance



M. D. Kempe, T. Moricone, M. Kilkenny, "Effects of Cerium Removal from Glass on Photovoltaic Module Performance and Stability", *SPIE*, San Diego, Ca, August 2-7, 2009.

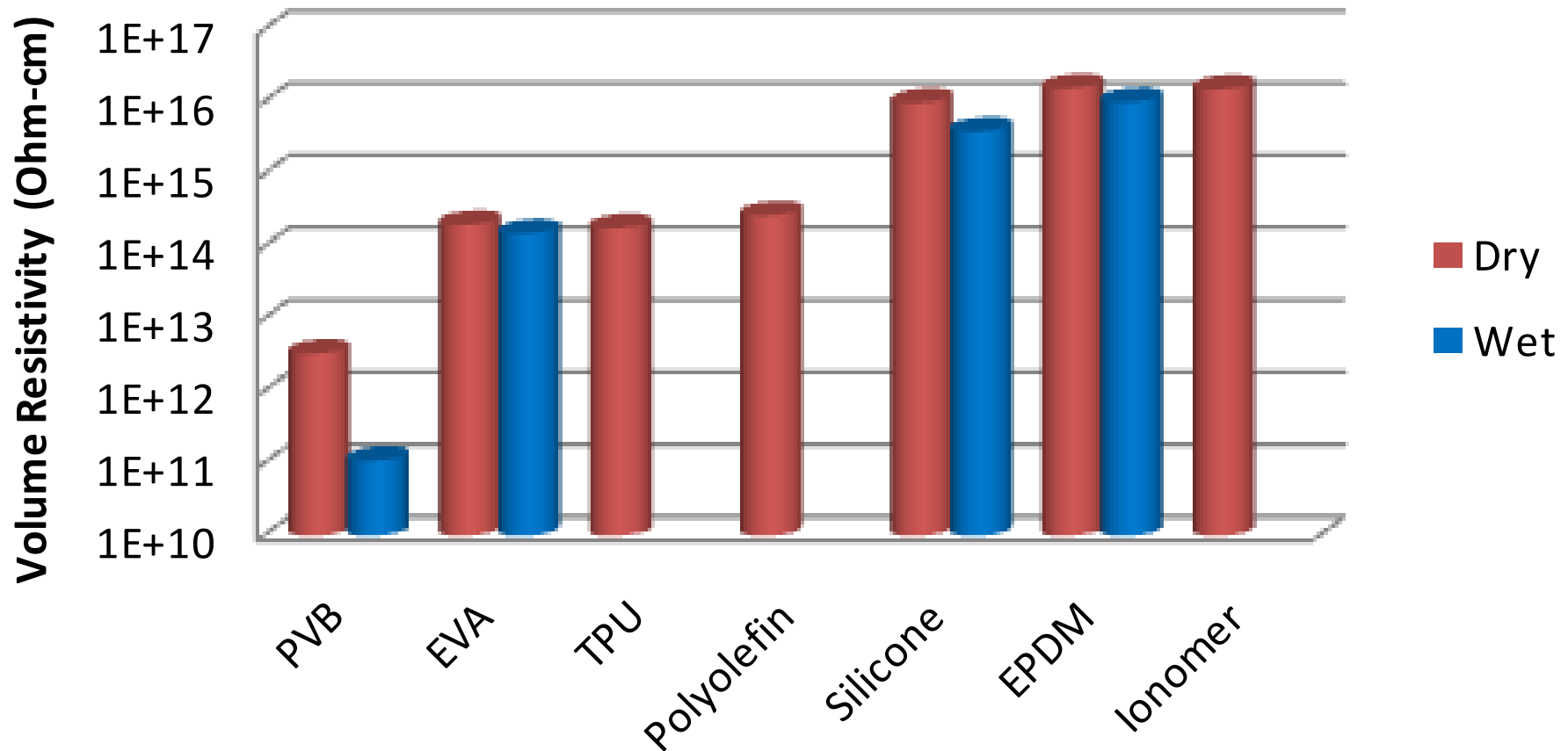
EVA Has Good Optical Transmittance

Encapsulant	Transmission to Cells through 3.18 mm glass and 0.45 mm Encapsulant	Comments
	%	
Momentive RTV615	94.5 ± 0.3	PDMS, Addition Cure
Dow Corning Sylgard 184	94.4 ± 0.3	PDMS, Addition Cure
Dow Corning 527	94.4 ± 0.3	PDMS, Addition Cure
Polyvinyl Butyral	93.9 ± 0.4	
EVA	93.9 ± 0.4	
NREL Experimental	93.4 ± 0.4	Poly- α -olefin
Thermoplastic Polyurethane	93.3 ± 0.3	
Thermoplastic Ionomer #1	92.3 ± 0.4	Copolymer of Ethylene and Methacrylic acid
Dow Corning 700	91.7 ± 0.3	PDMS, Acetic Acid Condensation Cure
Thermoplastic Ionomer #2	88.4 ± 0.4	Copolymer of Ethylene and Methacrylic acid

Solar photon-weighted average optical density determined from transmittance measurements through polymer samples of various thickness (1.5 to 5.5 mm) between two pieces of 3.18 mm thick Ce doped low Fe glass.

Electrical Conductivity Varies Greatly

Polymer Resistivity



Resistivity measured at 22°C using alternating polarity DC current a +/- 700V.

“Wet” samples were soaked in water at 40°C.

PVB, 1000 Times more Conductive than EVA

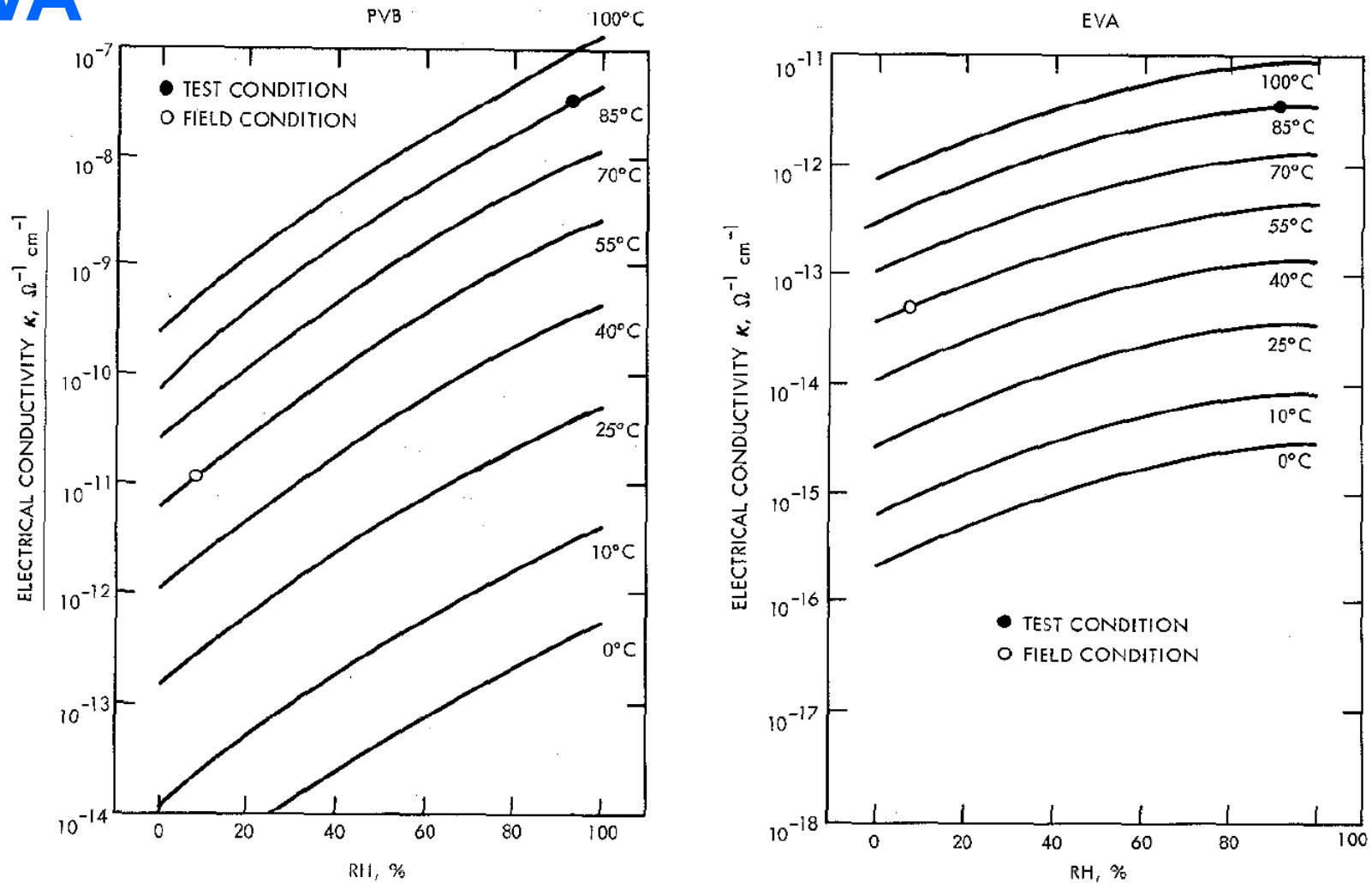


Figure 2. Bulk Electrical Conductivity of PVB and EVA

Leakage Current Correlates With Performance loss

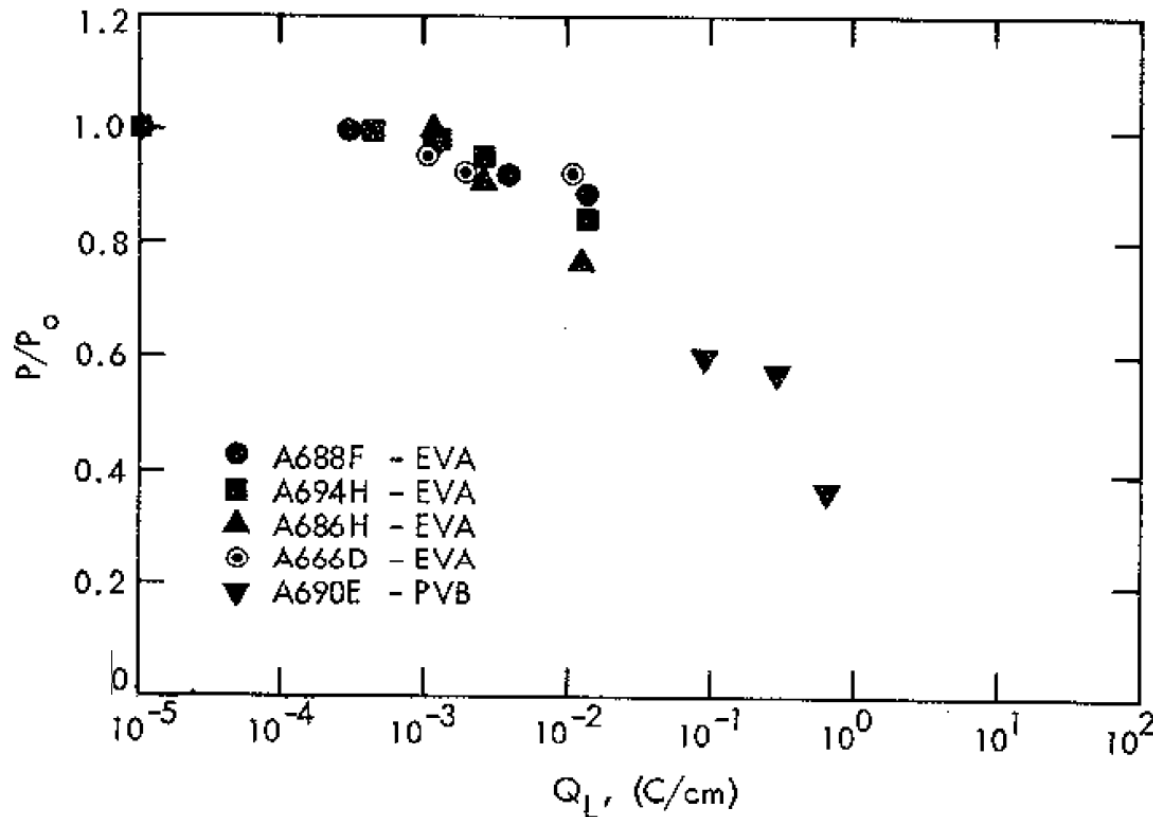


Figure 8. Power Output Reductions Versus Accumulated Unit Charge Transfer for α -Si Cells

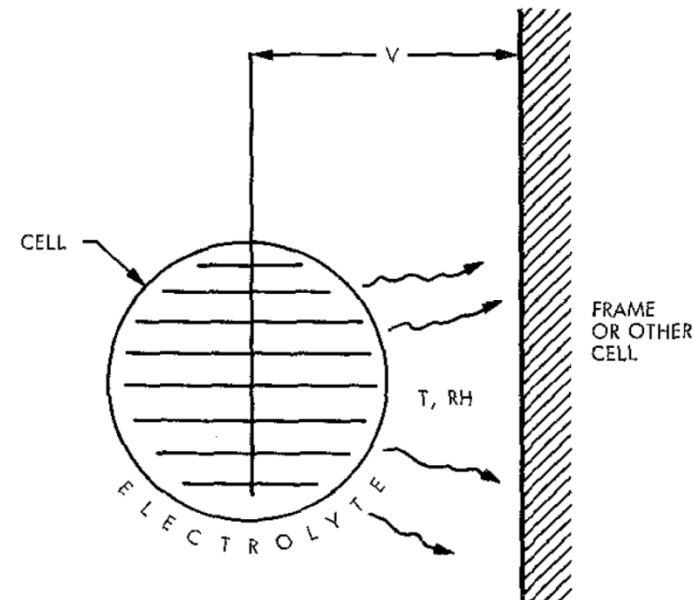
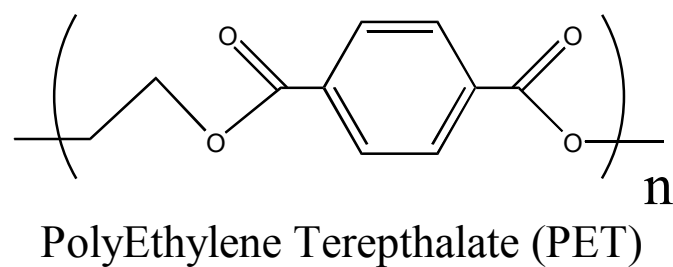
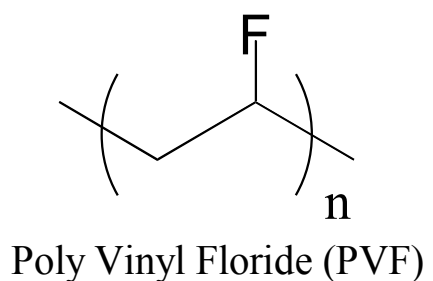


Figure 1. Corrosion Mechanism Overview

Backsheets Protect Against Electrical Shock

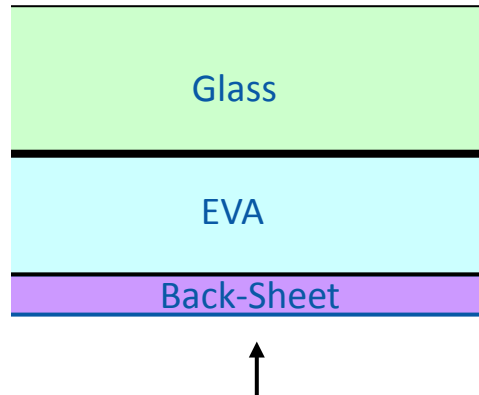


PET provides Electrical insulation.



PVF provides UV stability

Time Constant for Water Ingress



$$C(t) = C_o \left(1 - e^{-\frac{WVTR_{B,Sat} t}{C_{Sat,EVA} l_{EVA}}} \right)$$

$$\tau_{1/2} = 0.693 \frac{C_{Sat,EVA} l_{EVA}}{WVTR_{B,Sat}} = 0.693 \frac{\text{Amount of water EVA can hold}}{\text{Rate of moisture ingress}}$$

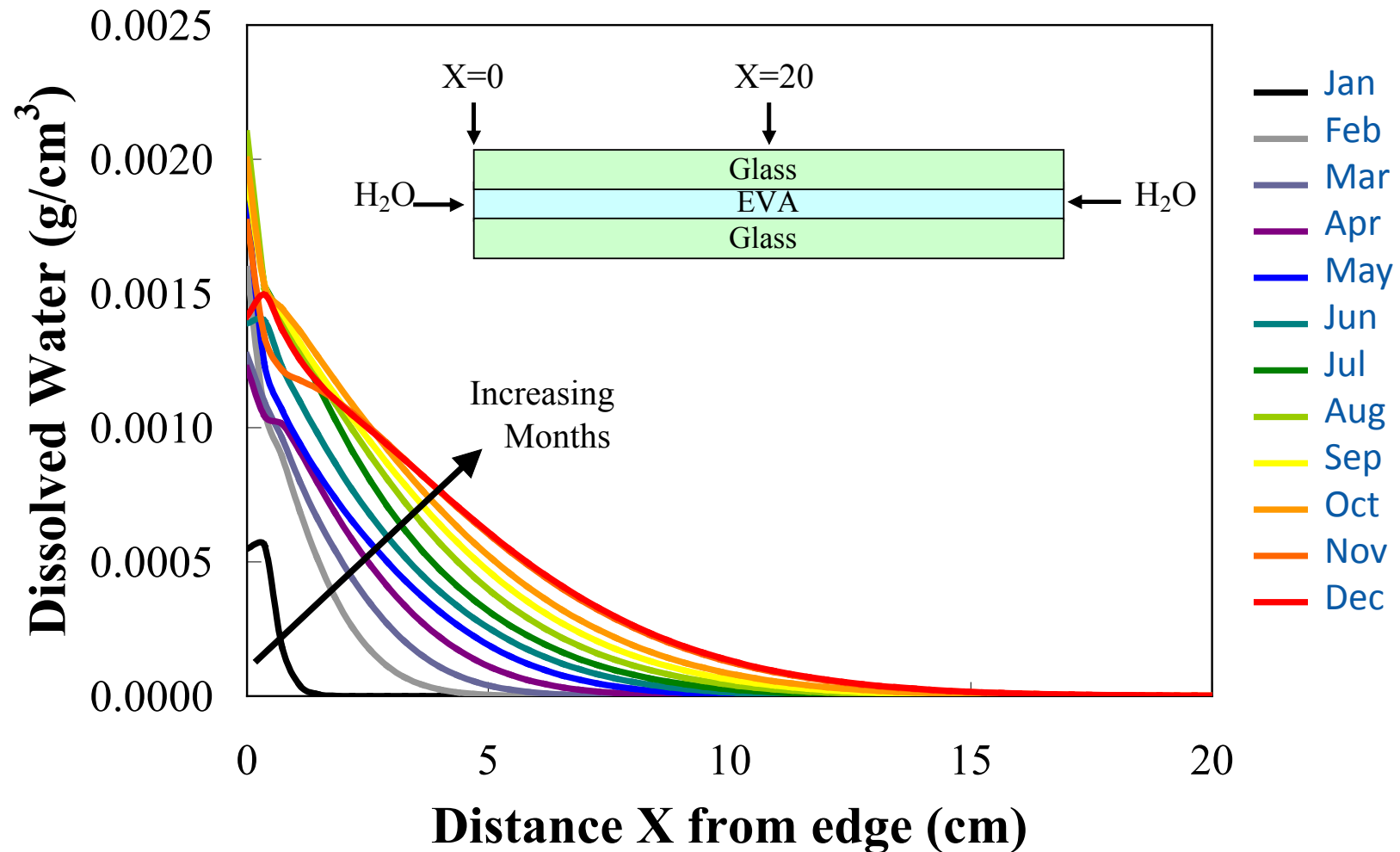
$$l_{EVA} = 18 \text{ mil}, T = 27^\circ \text{C}, C_{Sat,EVA} = 0.0022 \text{ g/cm}^3$$

	PVF	ETFE	PVF/PET	PET	PCTFE	
$\tau_{1/2} =$	0.0741	0.223	0.457	1.78	6.87	(day)

For $\tau_{1/2} = 20$ years need $10^{-4} \text{ g/m}^2/\text{day}$

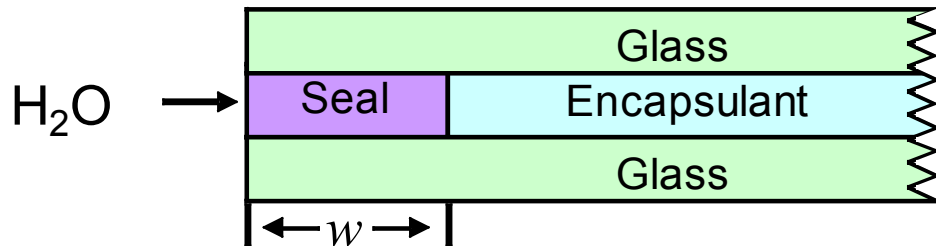
Even a Glass/Glass Module Will Let in Moisture

Finite element analysis using meteorological data from Miami Florida 2001

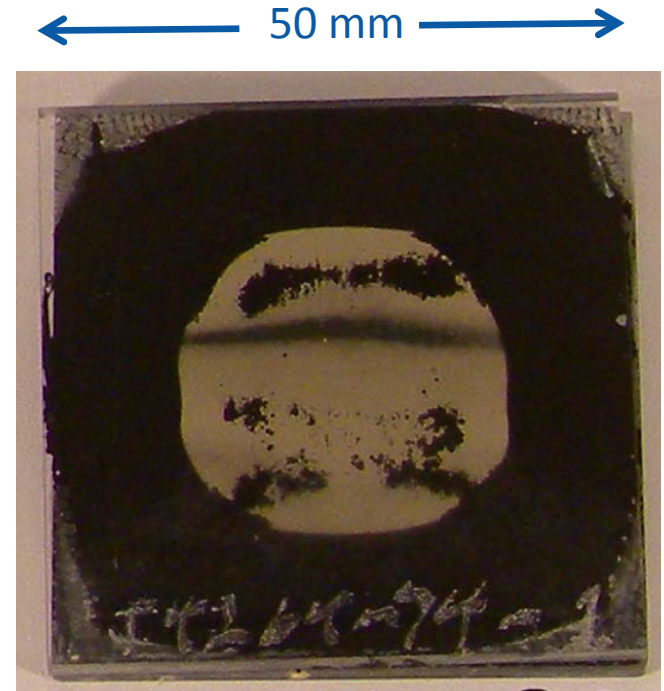
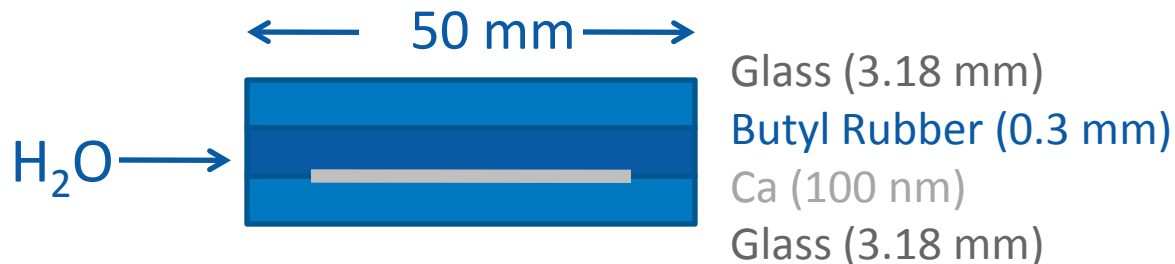


Edge Seals Can Keep Moisture Out

Schematic of module edge



Schematic of Test sample



PIB test sample after 3500 h
85°C and 85% RH

Conclusions

Packaging materials are formulated to:

- Resist to Heat, Humidity, UV Radiation, and Thermal Cycling.
- Provide Good Adhesion.
- Optically Couples Glass to Cells
- Electrically isolate components
- Control, reduce, or eliminate moisture ingress.

Choices made by Balancing cost With Performance.